

20V N-Channel PowerTrench⁰ MOSFET

General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low R_{DS(ON)} and fast switching speed.

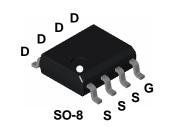
Applications

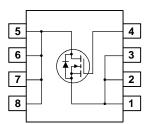
DC/DC converter



Features

- · Low gate charge
- High performance trench technology for extremely low R_{DS(ON)}
- · High power and current handling capability
- RoHS Compliant





Absolute Maximum Ratings T_A=25°C unless otherwise noted Symbol Parameter Ratings Units 20 V_{DSS} Drain-Source Voltage V V V_{GSS} Gate-Source Voltage ± 8 Drain Current – Continuous 16 А I_D (Note 1a) - Pulsed 80 P_D Power Dissipation for Single Operation 2.5 w (Note 1a) 1.2 (Note 1b) (Note 1c) 1.0 –55 to +175 T_J, T_{STG} Operating and Storage Junction Temperature Range °C **Thermal Characteristics** $R_{\theta JA}$ Thermal Resistance, Junction-to-Ambient (Note 1a) 50 °C/W Thermal Resistance, Junction-to-Case 25 °C/W $R_{\theta JC}$ (Note 1)

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
FDS6574A	FDS6574A	13"	12mm	2500 units

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@ V_{GS} = 2.5 V

@ V_{GS} = 1.8 V

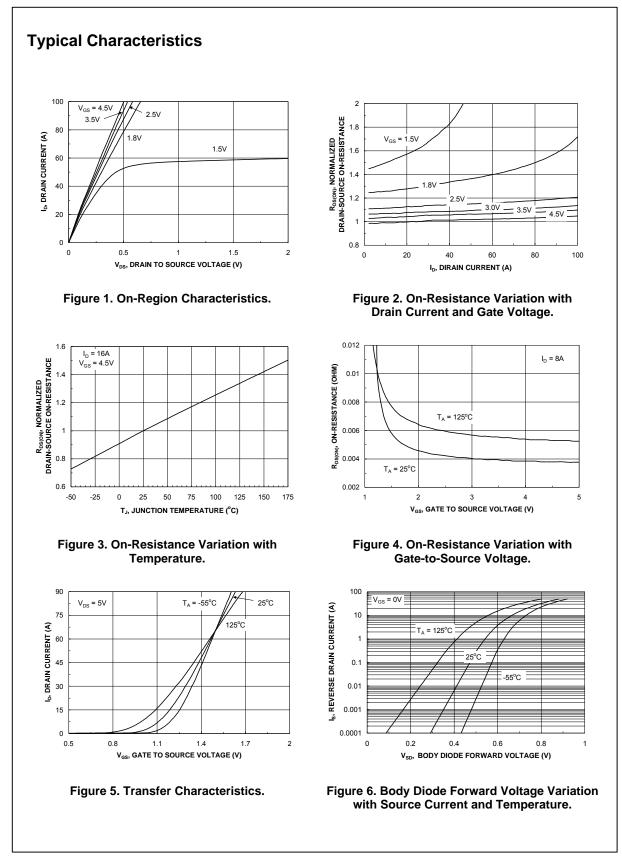
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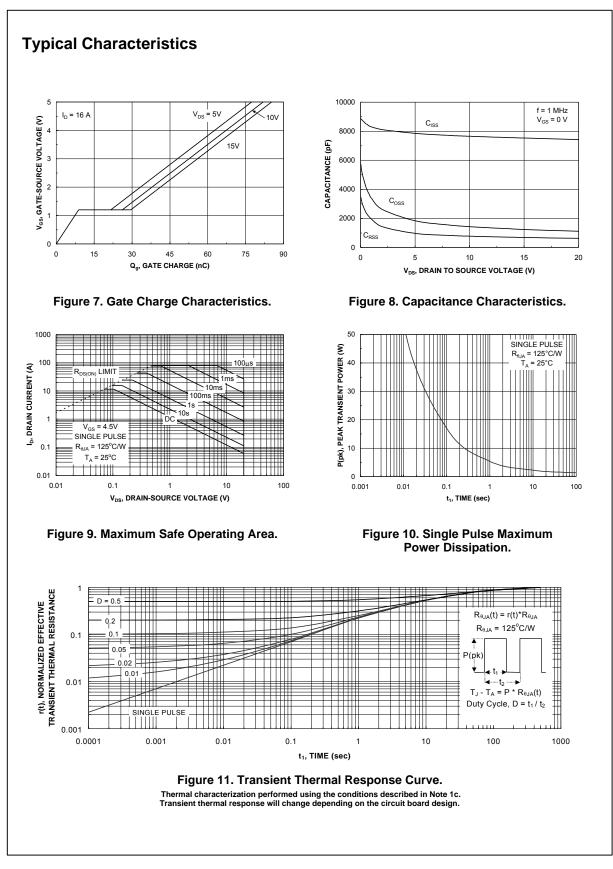
Scale 1 : 1 on letter size paper

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2. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%

FDS6574A Rev B2(W)





FDS6574A Rev B2(W)



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